

# PCIe 3.0 Clock Generator with 1 HCSL Outputs

#### **Features**

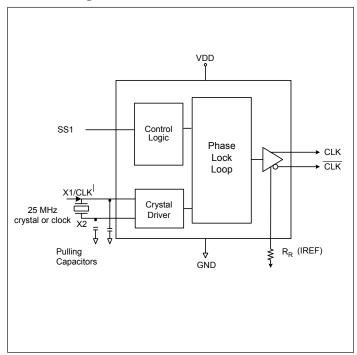
- → PCIe® 3.0 compliant
  - Phase jitter 0.45ps RMS (High Freq. Typ.)
- → LVDS compatible output
- → Supply voltage of 3.3V ±10%
- → 25MHz crystal or clock input frequency
- → HCSL outputs, 0.8V Current mode differential pair
- → Jitter 35ps cycle-to-cycle (typ)
- → Spread of -0.5% and no spread
- → Industrial temperature range
- → Spread Bypass option available
- → Spread selection via external pins
- → Packaging: (Pb-free and Green)
  - 16-pin TQFN

### **Description**

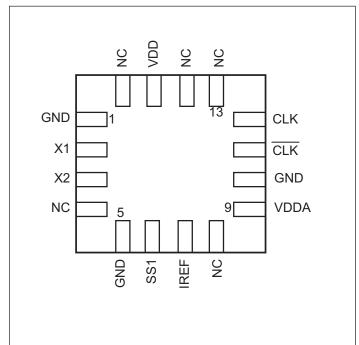
The PI6C557-01B is a spread spectrum clock generator compliant to PCI Express\* 3.0 and Ethernet requirements. The device is used for PC or embedded systems to substantially reduce Electromagnetic Interference (EMI).

The PI6C557-01B provides one differential (HCSL) or LVDS spread spectrum output. Using Pericom's patented Phase-Locked Loop (PLL) techniques, the device takes a 25MHz crystal input and produces one pair of differential outputs (HCSL) at 100MHz. It also provides spread selection of -0.5% and no spread.

### **Block Diagram**



### Pin Configuration (16-Pin TQFN)





### **Pin Description**

Pin#	Pin Name	I/O Type	Description
1	GND	Power	Connect to ground
2	X1	Input	Crystal or reference clock in
3	X2	Output	Xtal out. Leave unconnected for clock input.
4	NC	-	No connect. Must not be connected to GND
5	GND	Power	Connect to ground
6	SS1	Input	Spread select 1. Internall pull up resistor
7	IREF	Output	$475\Omega$ precision resistor attached to this pin is connected to the internal current reference.
8	NC	-	No connect. Must not be connected to GND
9	VDDA	Power	Connect to 3.3V source
10	GND	Power	Connect to ground
11	CLK	Output	HCSL complimentary clock output
12	CLK	Output	HCSL clock output
13	NC	-	No connect. Must not be connected to GND
14	NC	-	No connect. Must not be connected to GND
15	VDD	Power	Connect to 3.3V source for OSC and core
16	NC	-	No connect. Must not be connected to GND

**Table 1: Spread Selection Table** 

SS1	Spread		
0	Down -0.5%		
1	No Spread		



### **Application Information**

#### **Decoupling Capacitors**

Decoupling capacitors of 0.01  $\mu F$  should be connected between each  $V_{DD}$  pin and the ground plane and placed as close to the  $V_{DD}$  pin as possible.

#### Crystal

Use a 25MHz fundamental mode parallel resonant crystal with less than 300PPM of error across temperature.

#### **Crystal Capacitors**

C<sub>L</sub> = Crystals's load capacitance in pF

Crystal Capacitors (pF) =  $(C_L - 8) *2$ 

For example, for a crystal with 16pF load caps, the external effective crystal cap would be 16 pF. (16-8)\*2=16.

#### Current Source (IREF) Reference Resistor - RR

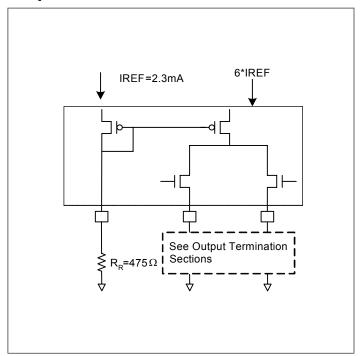
If board target trace impedance is  $50\Omega$ , then  $R_R=475\Omega$  providing an IREF of 2.32 mA. The output current ( $I_{OH}$ ) is 6\*IREF.

#### **Output Termination**

The PCI Express differential clock outputs of the PI6C557-01B are open source drivers and require an external series resistor and a resistor to ground. These resistor values and their allowable locations are shown in detail in the PCI Express Layout Guidelines section.

The PI6C557-01B can be configured for LVDS compatible voltage levels. See the LVDS Compatible Layout Guidelines section.

### **Output Structures**





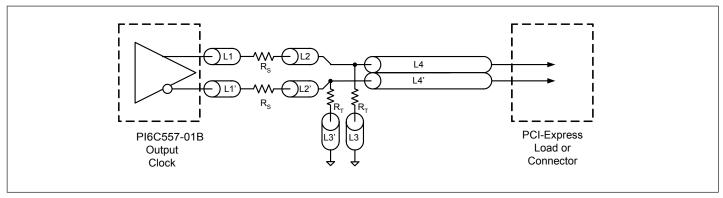
### **PCI Express Layout Guidelines**

Common Recommendations for Differential Routing	Dimension or Value	Unit
L1 length, route as non-coupled $50\Omega$ trace.	0.5 max	inch
L2 length, route as non-coupled $50\Omega$ trace.	0.2 max	inch
L3 length, route as non-coupled $50\Omega$ trace.	0.2 max	inch
$R_{S}$	33	Ω
$R_{\mathrm{T}}$	49.9	Ω

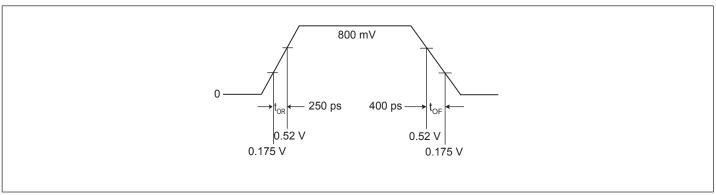
Differential Routing on a Single PCB	Dimension or Value	Unit
L4 length, route as coupled microstrip $100\Omega$ differential trace.	2 min to 16 max	inch
L4 length, route as coupled stripline $100\Omega$ differential trace.	1.8 min to 14.4 max	inch

Differential Routing to a PCI Express connector	Dimension or Value	Unit
L4 length, route as coupled microstrip $100\Omega$ differential trace.	0.25 min to 14 max	inch
L4 length, route as coupled stripline $100\Omega$ differential trace.	0.225 min to 12.6 max	inch

## **PCI Express Device Routing**



# Typical PCI Express (HCSL) Waveform

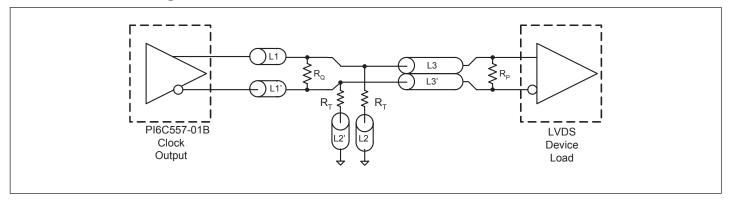




## **Application Information**

LVDS Recommendations for Differential Routing	Dimension or Value	Unit
L1 length, route as non-coupled $50\Omega$ trace.	0.5 max	inch
L2 length, route as non-coupled $50\Omega$ trace.	0.2 max	inch
RP	100	Ω
RQ	100	Ω
RT	150	Ω
L3 length, route as $100\Omega$ differential trace.		
L3 length, route as $100\Omega$ differential trace.		

## **LVDS Device Routing**





### **Maximum Ratings**

(Above which useful life may be impaired. For user guidelines, not tested.)

Comple Welton to Consul Detection
Supply Voltage to Ground Potential 5.5V
All Inputs and Outputs0.5V to V <sub>DD</sub> +0.5V
Ambient Operating Temperature40 to +85°C
Storage Temperature65 to +150°C
Junction Temperature
Soldering Temperature
EDS Protection (Input)

#### Note:

Stresses greater than those listed under MAXI-MUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

### **Electrical Specifications**

#### **Recommended Operation Conditions**

Parameter	Min.	Тур.	Max.	Unit
Ambient Operating Temperature			+85	°C
Power Supply Voltage (measured in respect to GND)	+3.0		+3.6	V

### DC Characteristics ( $V_{DD} = 3.3V \pm 10\%$ , $T_A = -40$ °C to +85°C)

Symbol	Parameter	Conditions		Min.	Тур.	Max.	Unit
$V_{\mathrm{DD}}$	Supply Voltage			3.0	3.3	3.6	V
$V_{\mathrm{IH}}$	Input High Voltage <sup>(1)</sup>			2.0		V <sub>DD</sub> +0.3	V
$V_{IL}$	Input Low Voltage <sup>(1)</sup>			GND -0.3		0.8	V
			With input pull-up and pull-downs	-20		20	
I <sub>IL</sub>	Input Leakage Current	$0 < Vin < V_{DD}$	Without input pull-up and pull-downs	-5		5	μΑ
$I_{DD}$	Operating Supply Current	$R_L = 50\Omega, C_L = 2pF$				95	mA
C <sub>IN</sub>	Input Capacitance	@ 55MHz				7	pF
Cout	Output Capacitance	@ 55MHz				6	pF
L <sub>PIN</sub>	Pin Inductance					5	nH
R <sub>OUT</sub>	Output Resistance	CLK Outputs		3.0			kΩ

#### Notes:

1. Single edge is monotonic when transitioning through region.



### HCSL Output AC Characteristics ( $V_{DD} = 3.3V \pm 10\%$ , $T_A = -40$ °C to +85°C)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$F_{IN}$	Input Frequency			25		MHz
F <sub>OUT</sub>	Output Frequency			100		MHz
V <sub>OH</sub>	Output High Voltage (1,2)	100 MHz HCSL output @ $V_{\rm DD}$ = 3.3V	660	800	900	mV
V <sub>OL</sub>	Output Low Voltage(1,2)		-150	0		mV
V <sub>CPA</sub>	Crossing Point Voltage <sup>(1,2)</sup>	Absolute	250	350	550	mV
V <sub>CN</sub>	Crossing Point Voltage(1,2,4)	Variation over all edges			140	mV
Jcc	Jitter, Cycle-to-Cycle <sup>(1,3)</sup>			35	60	ps
J <sub>RMS</sub>	PCIe 2.0 RMS Jitter	PCIe 2.0 Test Method @ 100MHz Output			3.1	ps
	PCIe 3.0 RMS Jitter	PLL L-BW @ 2M & 5M 1st H3		1.75	3	ps
T		PLL L-BW @ 2M & 4M 1st H3		2.18	3	ps
J <sub>RMS3.0</sub>		PLL H-BW @ 2M & 5M 1st H3		0.45	1	ps
		PLL H-BW @ 2M & 4M 1st H3		0.45	1	ps
MF	Modulation Frequency	Spread Spectrum	30	31.5	33	kHz
t <sub>OR</sub>	Rise Time <sup>(1,2)</sup>	From 0.175V to 0.525V	175		500	ps
t <sub>OF</sub>	Fall Time <sup>(1,2)</sup>	From 0.525V to 0.175V	175		500	ps
T <sub>DUTY-CYCLE</sub>	Duty Cycle <sup>(1,3)</sup>		45		55	%
tstable	From power-up to V <sub>DD</sub> =3.3V	From Power-up V <sub>DD</sub> =3.3V		3.0		ms
t <sub>SPREAD</sub>	Setting period after spread change	Setting period after spread change		3.0		ms

#### Notes:

- 1.  $R_L = 50$ -Ohm with  $C_L = 2 pF$
- 2. Single-ended waveform
- 3. Differential waveform
- 4. Measured at the crossing point

#### **Thermal Characteristics**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$\theta_{\mathrm{JA}}$	Thermal Resistance Junction to Ambient	Still air			57.70	°C/W
$\theta_{ m JC}$	Thermal Resistance Junction to Case				32.20	°C/W

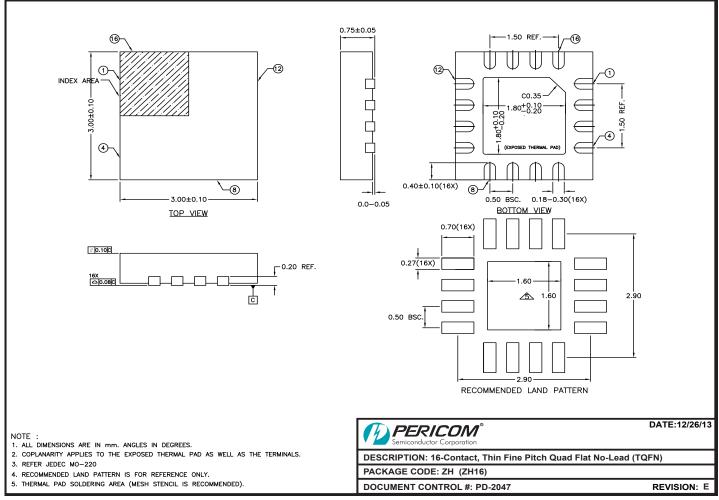
### **Recomended Crystal Specification**

#### Pericom recommends:

- a) GC2500003 XTAL 49S/SMD(4.0 mm), 25M, CL=18pF, +/-30ppm http://www.pericom.com/pdf/datasheets/se/GC\_GF.pdf
- b) FY2500107, SMD 5x3.2(4P), 25M, CL=18pF, +/-30ppm http://www.pericom.com/pdf/datasheets/se/FY\_F9.pdf
- c) FL2500038, SMD 3.2x2.5(4P), 25M, CL=18pF, +/-20ppm http://www.pericom.com/pdf/datasheets/se/FL.pdf



### Packaging Mechanical: 16-Pin TQFN (ZH)



 $Note: For \ latest\ package\ info,\ please\ check:\ http://www.pericom.com/products/packaging/mechanicals.php$ 

### **Ordering Information**

Ordering Code	Package Code	Package Type	Operating Temperature
PI6C557-01BZHIE	ZH	Pb-free & Green, 16-pin TQFN	Industrial

#### Notes:

- Thermal characteristics can be found on the company web site at www.pericom.com/packaging/
- "E" denotes Pb-free and Green
- Adding an "X" at the end of the ordering code denotes tape and reel packaging

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PI6C557-01BZHIE PI6C557-01BZHIEX PI6C557-01BQZHIEX